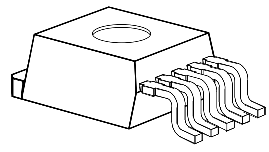
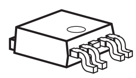
5-V Low Drop Fixed Voltage Regulator **TLE 4270-2**

Features





- Output voltage tolerance ≤ ±2%
- 650 mA output current capability
- Low-drop voltage
- Reset functionality
- Adjustable reset time
- Suitable for use in automotive electronics
- Integrated overtemperature protection
- Reverse polarity protection
- Input voltage up to 42 V
- Overvoltage protection up to 65 V (≤ 400 ms)
- Short-circuit proof
- Wide temperature range
- ESD protection: ±2kV HBM[1)]
- Green Product (RoHS compliant)
- AEC Qualified

Functional Description

This device is a 5-V low drop fixed-voltage regulator. The maximum input voltage is 42 V (65 V, ≤ 400 ms). Up to an input voltage of 26 V and for an output current up to 650 mA it regulates the output voltage within a 2% accuracy. The short circuit protection limits the output current of more than 650 mA. The device incorporates overvoltage protection and a temperature protection which turns off the device at high temperatures.

1) ESD susceptibility, Human Body Model (HBM) according to EIA/JESD 22-A114B

Type	Package
TLE 4270-2 G	PG-TO263-5-1
TLE 4270-2 D	PG-TO252-5-11

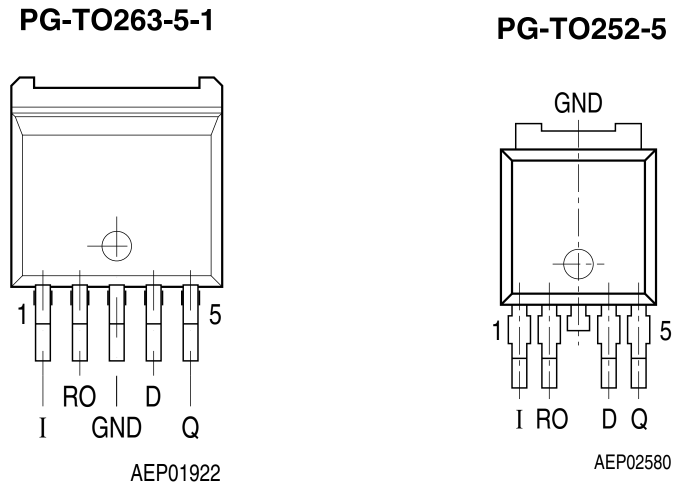


Figure 1 **Pin Configuration** (top view)

Table 1 **Pin Definitions and Functions**

Pin	Symbol	Function
1	I	**Input;** block to ground directly at the IC with a ceramic capacitor.
2	RO	**Reset Output;** the open collector output is connected to the 5-V output via an integrated resistor of 30 kΩ.
3	GND	**Ground;** internally connected to heatsink.
4	D	**Reset Delay;** connect a capacitor to ground for delay time adjustment.
5	Q	**5-V Output;** block to ground with 22 µF capacitor, ESR < 3 Ω.

Circuit Description

The control amplifier compares a reference voltage, which is kept highly accurate by resistance adjustment, to a voltage that is proportional to the output voltage and drives the base of a series transistor via a buffer. Saturation control as a function of the load current prevents any over-saturation of the power element.

The IC also incorporates a number of internal circuits for protection against:

- Overload
- Overvoltage
- Overtemperature
- Reverse polarity

Application Description

The IC regulates an input voltage in the range of 5.5 V < V_I < 36 V to $V_{Q,nom}$ = 5.0 V. Up to 26 V it produces a regulated output current of more than 650 mA. Above 26 V the save-operating-area protection allows operation up to 36 V with a regulated output current of more than 300 mA. Overvoltage protection limits operation at 42 V. The overvoltage protection hysteresis restores operation if the input voltage has dropped below 36 V. A reset signal is generated for an output voltage of V_Q < 4.5 V. The delay for power-on reset can be set externally with a capacitor.

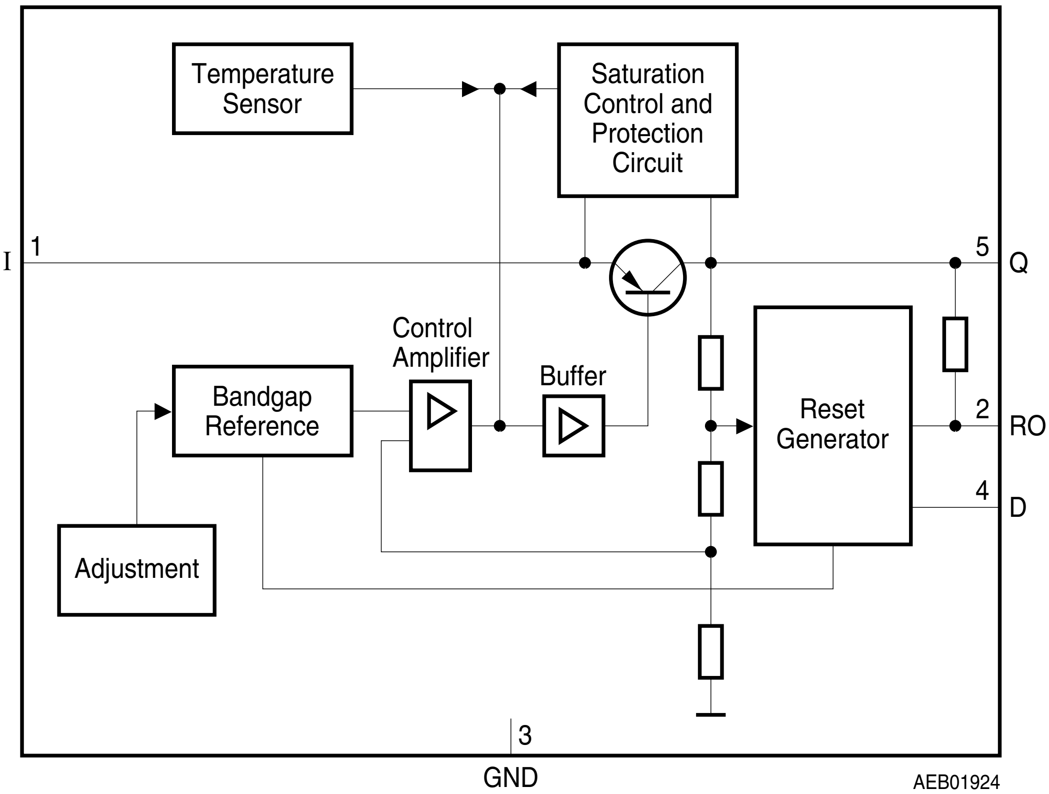


Figure 2 Block Diagram

Table 2 Absolute Maximum Ratings

T_j = -40 to 150 °C

Parameter	Symbol	Limit Values		Unit	Notes
		Min.	Max.		
Input I					
Voltage	V_I	-42	42	V	–
Voltage	V_I	–	65	V	$t \leq$ 400 ms
Current	I_I	–	–	–	internally limited
Reset Output RO					
Voltage	V_{RO}	-0.3	7	V	–
Current	I_{RO}	–	–	–	Internally limited
Reset Delay D					
Voltage	V_D	-0.3	7	V	–
Current	I_D	–	–	–	Internally limited
Output Q					
Voltage	V_Q	-1.0	16	V	–
Current	I_Q	–	–	–	Internally limited
Ground GND					
Current	I_{GND}	-0.5	–	A	–
Temperatures					
Junction temperature	T_j	–	150	°C	–
Storage temperature	T_{stg}	-50	150	°C	–

Table 3 Operating Range

Parameter	Symbol	Limit Values		Unit	Notes
		Min.	Max.		
Input voltage	V_I	6	42	V	–
Junction temperature	T_j	-40	150	°C	–
Thermal Resistance					
Junction ambient	R_{thj-a}	–	65	K/W	–
			79	K/W	TO263, TO252[1)]
Junction case	R_{thj-c}	–	3	K/W	TO-263 Packages

1) Mounted on PCB, 80 × 80 × 1.5 mm^3; 35µ Cu; 5µ Sn; Footprint only; zero airflow.

Table 4 Characteristics

V_I = 13.5 V; -40 °C ≤ T_j ≤ 125 °C (unless otherwise specified)

Parameter	Symbol	Limit Values			Unit	Test Condition
		Min.	Typ.	Max.		
Output voltage	V_Q	4.90	5.00	5.10	V	5 mA ≤ I_Q ≤ 550 mA; 6 V ≤ V_I ≤ 26 V
Output voltage	V_Q	4.90	5.00	5.10	V	26 V ≤ V_I ≤ 36 V; I_Q ≤ 300 mA
Output current limiting	I_{Qmax}	650	850	–	mA	V_Q = 0 V
Current consumption $I_q = I_I - I_Q$	I_q	–	1	1.5	mA	I_Q = 5 mA
Current consumption $I_q = I_I - I_Q$	I_q	–	55	75	mA	I_Q = 550 mA
Current consumption $I_q = I_I - I_Q$	I_q	–	70	90	mA	I_Q = 550 mA; V_I = 5 V
Drop voltage	V_{DR}	–	350	700	mV	I_Q = 550 mA[1]
Load regulation	$\Delta V_{Q,Lo}$	–	25	50	mV	I_Q = 5 to 550 mA; V_I = 6 V
Line regulation	$\Delta V_{Q,Li}$	–	12	25	mV	V_I = 6 to 26 V I_Q = 5 mA
Power supply Ripple rejection	$PSRR$	–	54	–	dB	f_r = 100 Hz; V_r = 0.5 Vpp
Reset Generator						
Switching threshold	V_{RT}	4.5	4.65	4.8	V	–
Reset High voltage	V_{ROH}	4.5	–	–	V	–
Reset low voltage	V_{ROL}	–	60	–	mV	R_{int} = 30 kΩ[2]; 1.0 V ≤ V_Q ≤ 4.5 V
Reset low voltage	V_{ROL}	–	200	400	mV	I_R = 3 mA, V_Q = 4.4 V
Reset pull-up	R_{int}	18	30	46	kΩ	internally connected to Q
Charge current	$I_{D,c}$	8	14	25	µA	V_D = 1.0 V

Table 4 Characteristics (cont'd)

V_I = 13.5 V; -40 °C ≤ T_j ≤ 125 °C (unless otherwise specified)

Parameter	Symbol	Limit Values			Unit	Test Condition
		Min.	Typ.	Max.		
Upper reset timing threshold	V_{DU}	1.4	1.8	2.3	V	–
Lower reset timing threshold	V_{DL}	0.2	0.45	0.8	V	$V_Q < V_{RT}$
Delay time	t_{rd}	–	13	–	ms	C_D = 100 nF
Reset reaction time	t_{rr}	–	–	3	µs	C_D = 100 nF
Overvoltage Protection						
Turn-Off voltage	$V_{I,\ ov}$	42	44	46	V	–

1) Drop voltage = V_I - V_Q (measured when the output voltage has dropped 100 mV from the nominal value obtained at 13.5 V input)

2) Reset peak is always lower than 1.0 V.

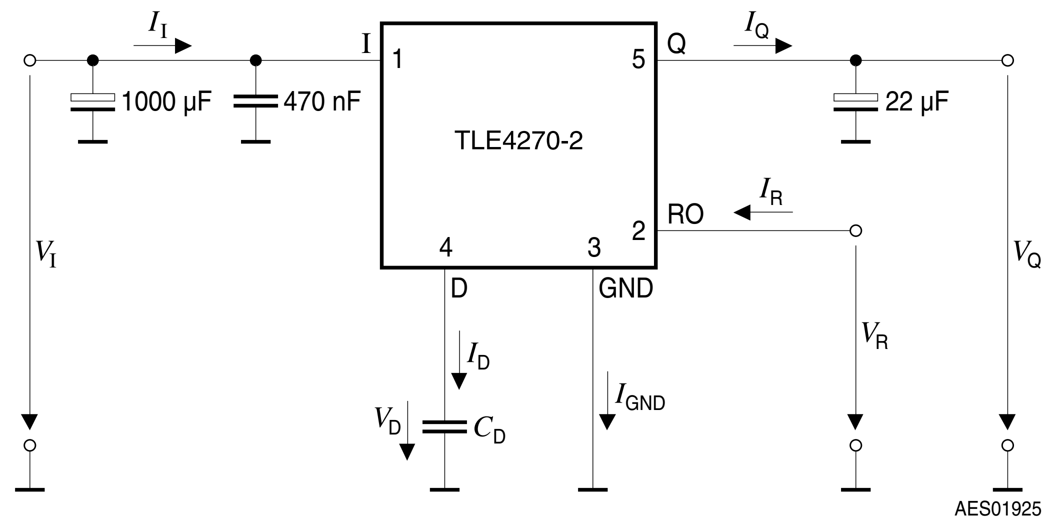


Figure 3 Test Circuit

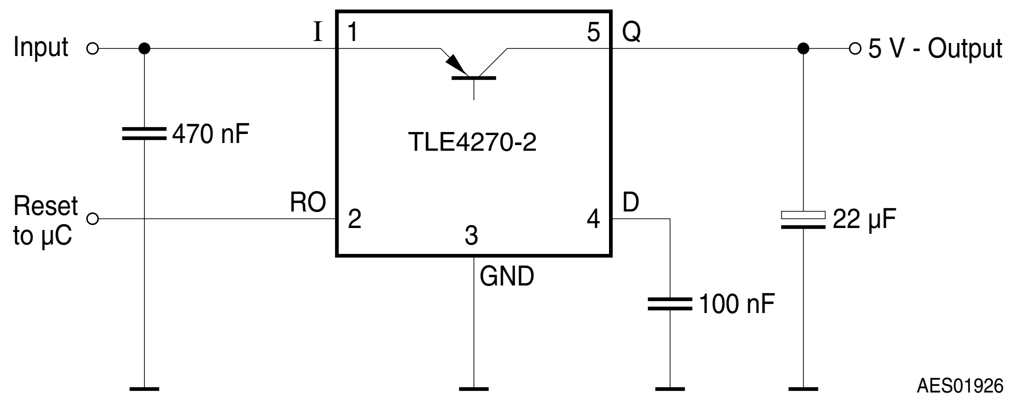


Figure 4 Application Circuit

Design Notes for External Components

An input capacitor C_I is necessary for compensation of line influences. The resonant circuit consisting of lead inductance and input capacitance can be damped by a resistor of approx. 1 Ω in series with C_I. An output capacitor C_Q is necessary for the stability of the regulating circuit. Stability is guaranteed at values of $C_Q \geq 22\ \mu F$ and an ESR of < 3 Ω.

Reset Circuitry

If the output voltage decreases below 4.5 V, an external capacitor C_D on pin 4 (D) will be discharged by the reset generator. If the voltage on this capacitor drops below V_{DL}, a reset signal is generated on pin 2 (RO), i.e. reset output is set low. If the output voltage rises above the reset threshold, C_D will be charged with constant current. After the power-on-reset time the voltage on the capacitor reaches V_{DU} and the reset output will be set high again. The value of the power-on-reset time can be set within a wide range depending of the capacitance of C_D.

Reset Timing

The power-on reset delay time is defined by the charging time of an external capacitor C_D which can be calculated as follows:

$$C_D = (\Delta t \times I_{D,c})/\Delta V \quad (1)$$

Definitions:

- C_D = delay capacitors
- Δt = reset delay time t_{rd}
- $I_{D,c}$ = charge current, typical 14 µA
- $\Delta V = V_{DU}$, typical 1.8 V

V_{DU} = upper reset timing threshold at C_D for reset delay time

$$t_{rd} = \Delta V \times C_D / I_{D,c} \quad (2)$$

The reset reaction time t_{rr} is the time it takes the voltage regulator to set the reset out LOW after the output voltage has dropped below the reset threshold. It is typically 1 µs for delay capacitor of 47 nF. For other values for C_D the reaction time can be estimated using the following equation:

$$t_{rr} \approx 20\ s/F \times C_D \quad (3)$$

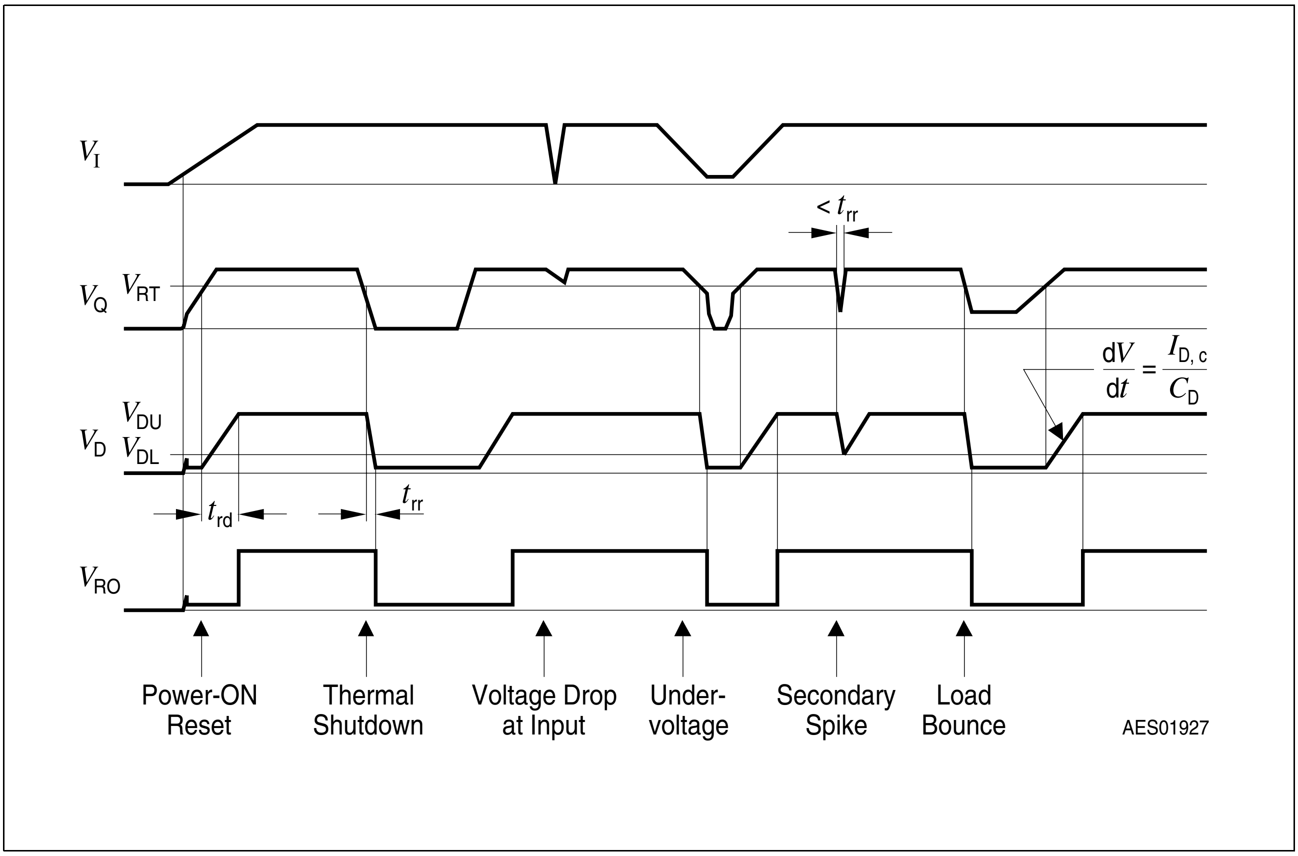
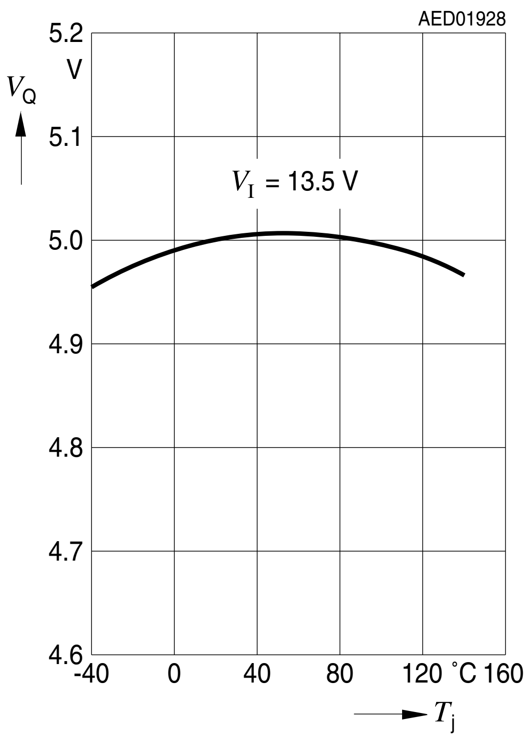
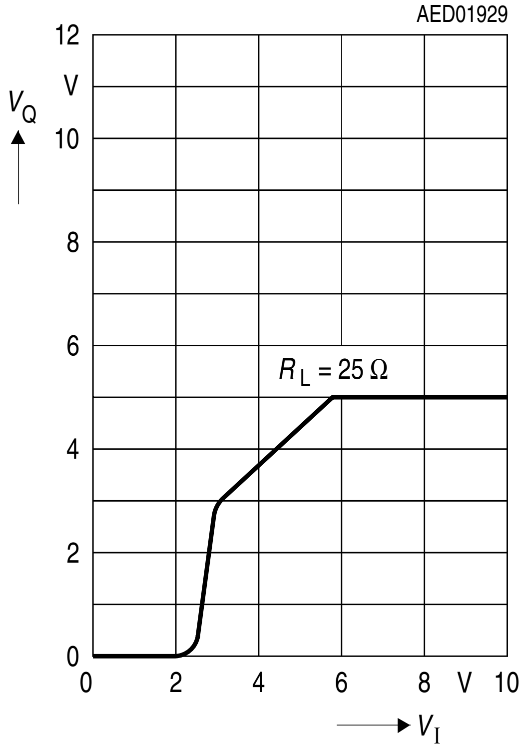


Figure 5 Reset Time Response

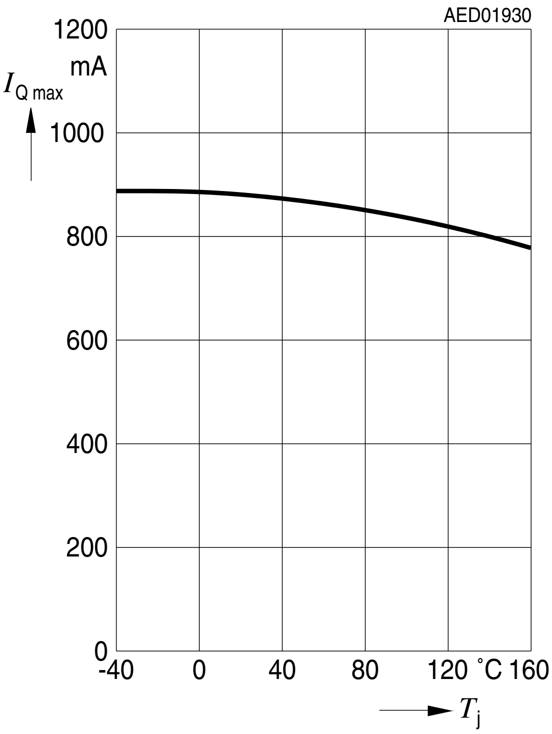
Output Voltage V_Q versus Temperature T_j



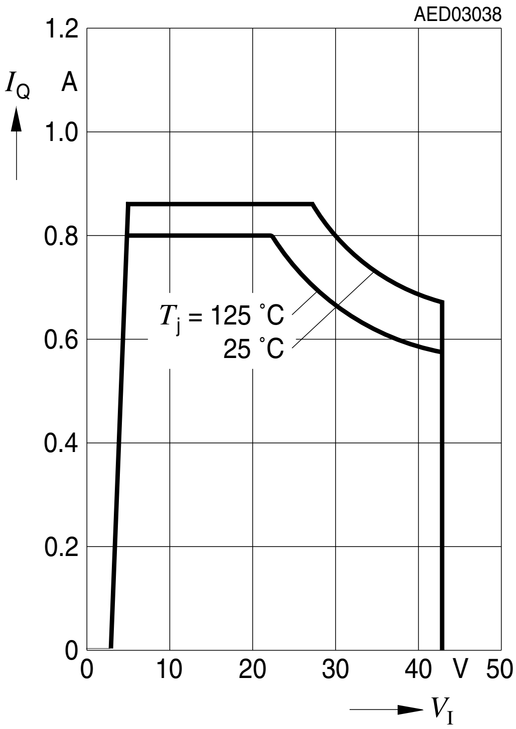
Output Voltage V_Q versus Input Voltage V_I



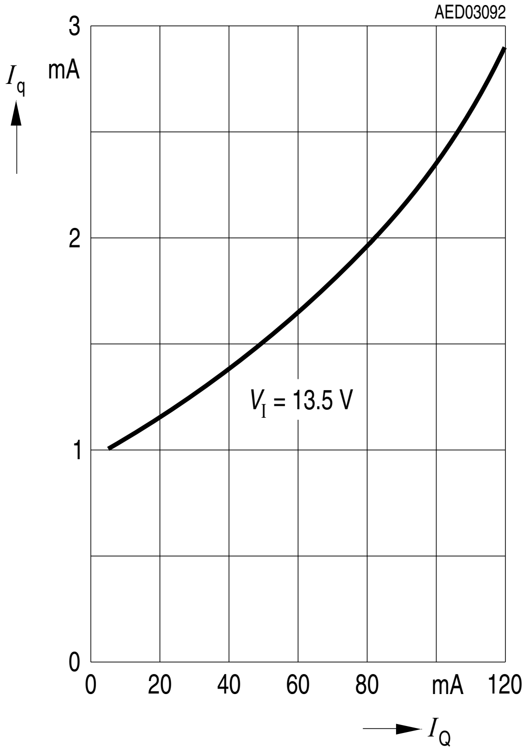
Output Current I_Q versus Temperature T_j



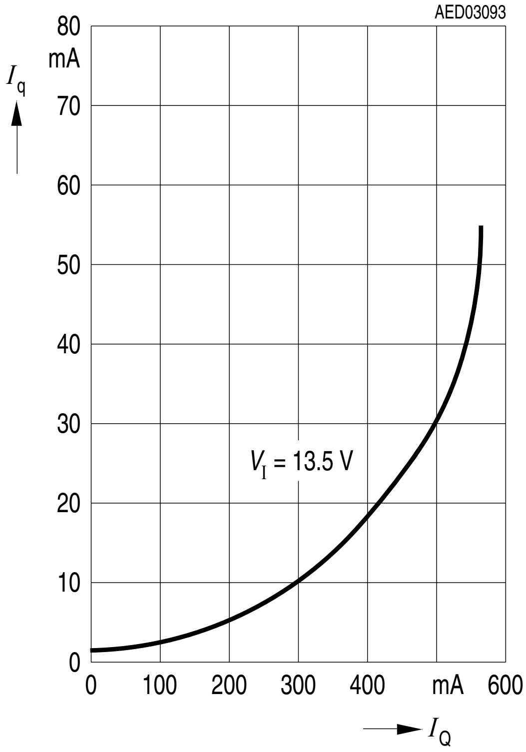
Output Current I_Q versus Input Voltage V_I



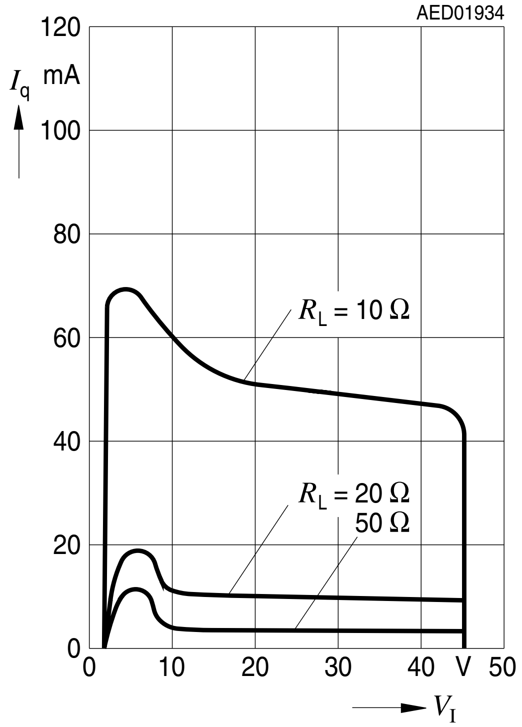
Current Consumption I_q versus Output Current I_Q



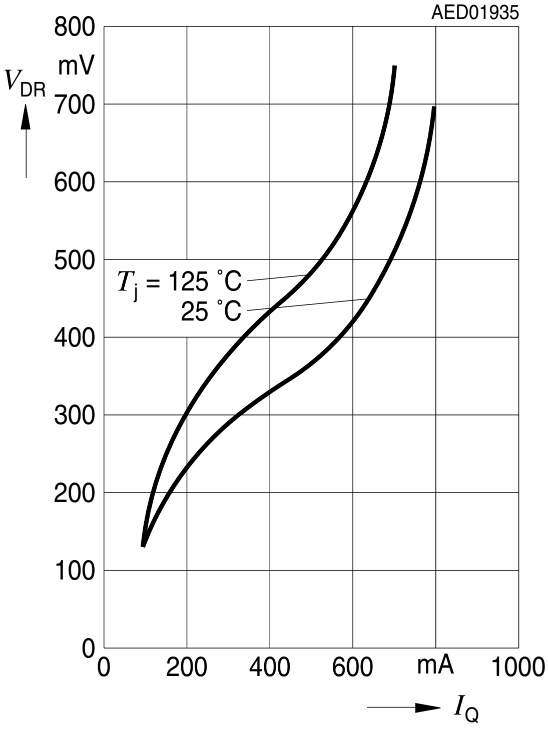
Current Consumption I_q versus Output Current I_Q



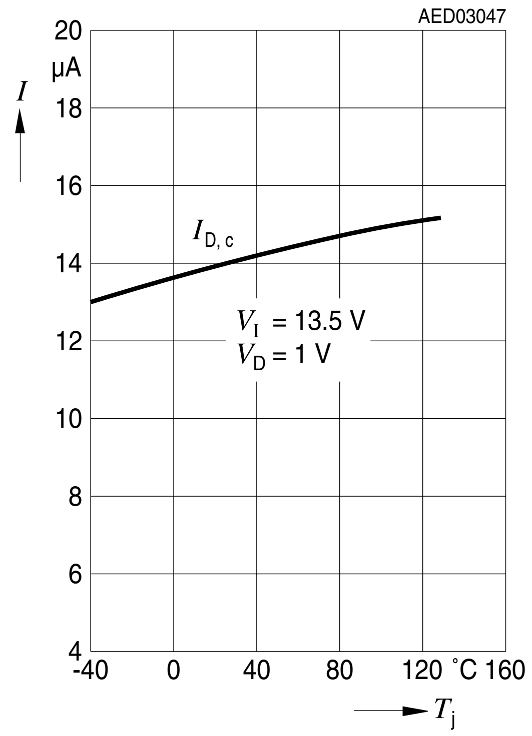
Current Consumption I_q versus Input Voltage V_I



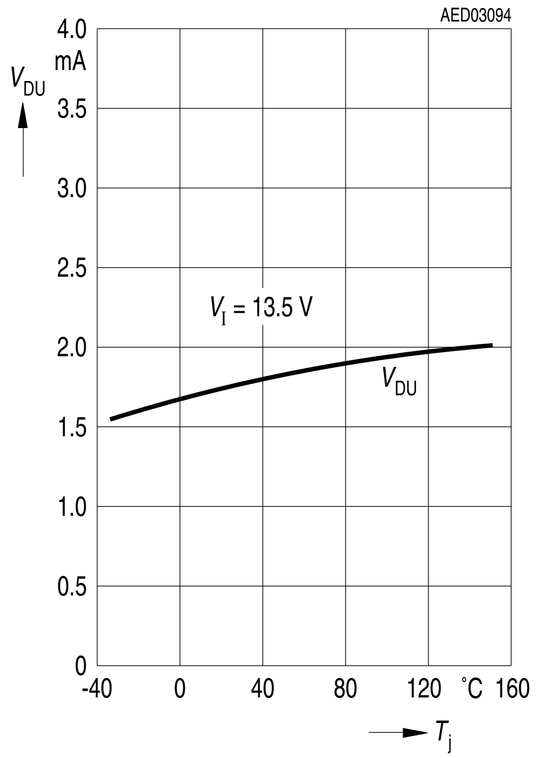
Drop Voltage V_{DR} versus Output Current I_Q



Charge Current $I_{D,c}$ versus Temperature T_j



Upper Reset Timing Threshold V_{DU} versus Temperature T_j



Package Outlines

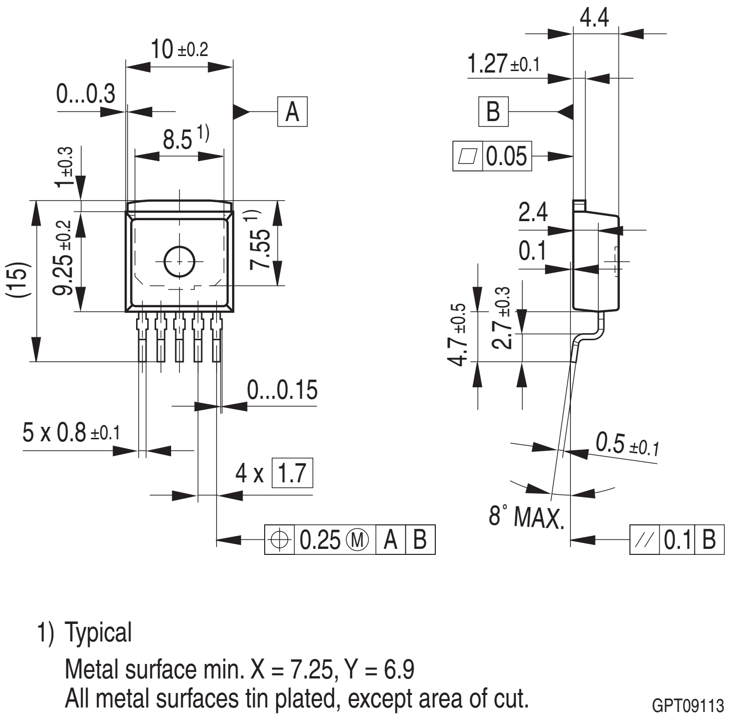


Figure 6 **PG-TO263-5-1** (Plastic Transistor Single Outline)

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

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SMD = Surface Mounted Device

Dimensions in mm

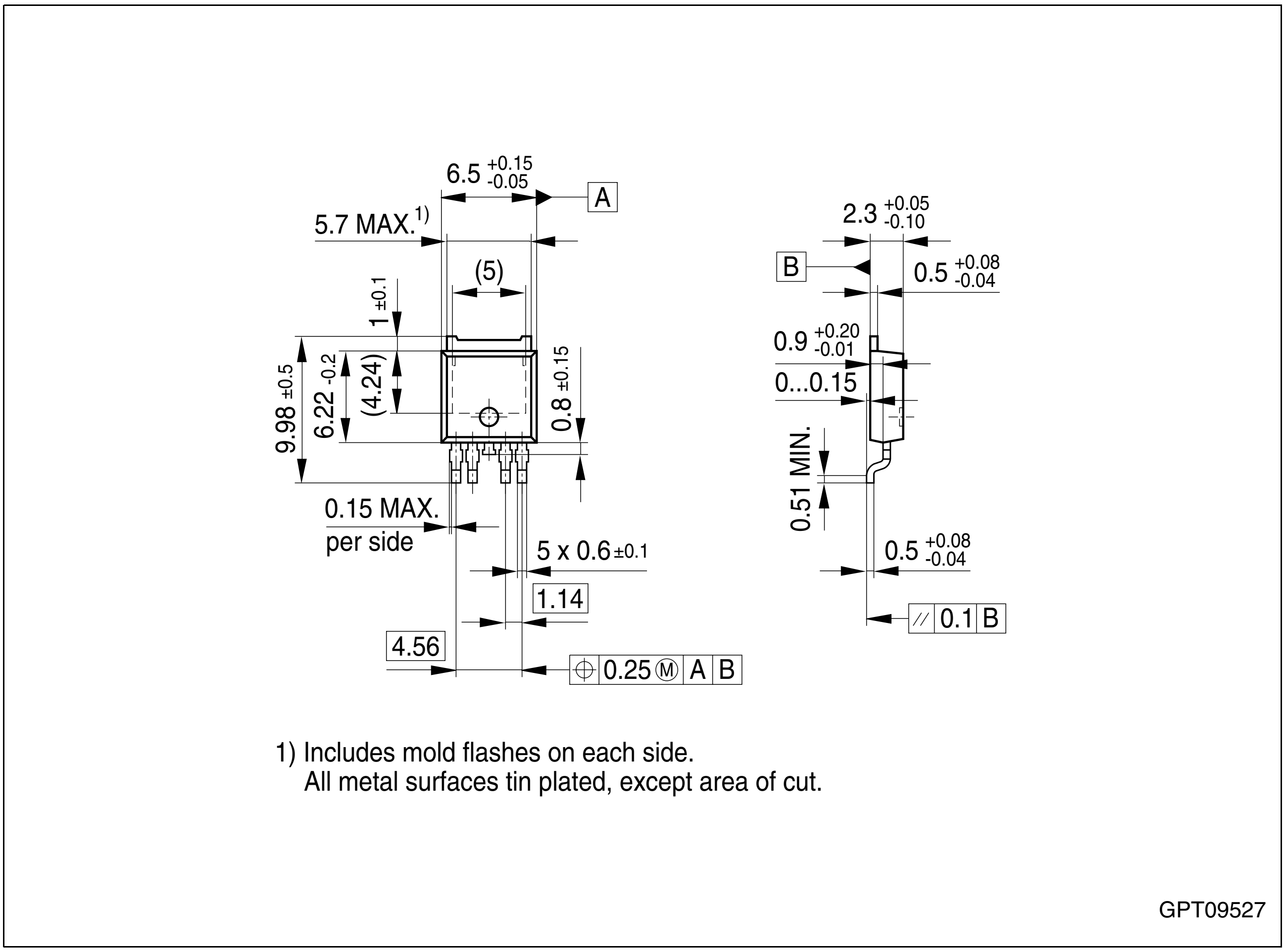

Figure 7 **PG-TO252-5-11** (Plastic Transistor Single Outline)

Green Product (RoHS compliant)

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SMD = Surface Mounted Device

Dimensions in mm

Revision History

Version	Date	Changes
Rev. 1.8	2007-11-09	**Page 1**: Changed ESD specification from ">4000V" to "±2kV HBM" according to PCN No. 2007-089
Rev. 1.7	2007-03-20	Initial version of RoHS-compliant derivate of TLE 4270 Change of product name to TLE 4270-2 due to modified chip layout and size. **Page 1**: AEC certified statement added **Page 1** and **Page 14**: RoHS compliance statement and Green product feature added **Page 1** and **Page 14**: Package changed to RoHS compliant version Legal Disclaimer updated

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